

ESPI Current Report

Number: 24/2022

Date of preparation: 22 July 2022

Company: XTPL S.A., a joint stock company with its registered office in Wrocław

Title: Acceptance of an order for the delivery of a printing module for industrial integration in the prototype of an industrial device for applications in semiconductor production for a Partner from Taiwan.

Legal basis: Article 17(1) MAR – inside information

Content of the Report: The Management Board of XTPL S.A. (the “Issuer”, “Company”, “XTPL”) hereby reports that on 22 July 2022 it confirmed the acceptance of an order for the delivery of a printing module for industrial integration. The order was received from a Taiwan-based global manufacturer of specialized equipment for the production of semiconductor components (“Partner”). Acceptance of the order means delivery of the XTPL technology to build a prototype of an industrial device for applications in semiconductor production.

The Partner's decision to buy the printing module and start the construction of a prototype industrial device was taken following a complex process consisting of three stages of evaluation of XTPL's technological solutions in cooperation with the Partner in Taiwan (equipment manufacturer) and a Client, also Taiwan-based – a leading global manufacturer of semiconductors (“Client”, “End Client”). The complex evaluation process with the Partner took about 18 months to complete.

The XTPL printing module will be an essential element of the industrial device prototype for advanced packaging applications in the semiconductor industry. The Company's printing module will be integrated into the prototype of the device, which is to meet the technological requirements set for the Partner by the End Client.

Sales revenue connected with the order will be recognized by the end of 2022.

The Issuer's Management Board has decided that the commencement of execution of the order for the delivery of the printing module for industrial integration is inside information due to the achievement of a key level of technology evaluation with a potentially significant importance for the Company's future development. The order opens up another stage of close cooperation between the Company and the Partner, ultimately geared towards development and industrial implementation of the device on production lines of the Taiwan-based leading global manufacturer of semiconductor components. The cooperation also confirms the attractiveness of the technological solution offered by the Company and the further commercialization potential of the XTPL technology as part of its business line of printing modules for industrial integration.

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Accordingly, in the opinion of the Issuer's Management Board, the above information meets the criteria of inside information within the meaning of Article 7(1) MAR.

Signatures of persons representing the Company:
Jacek Olszański – Management Board Member